



美格智能

SRM810 模组

5G NR LGA

5G	SRM810	!	IoT/	/eMBB	5G Sub-6GHz
LGA	\$	30.0x41.0x2.7mm	*	+	V510
15	5G	SA	NSA	7	13GPP Release
4G/3G网			5G		
SRM810				7	USB3.0 PCIe2.0 SDIO SPI A
UART ADC GPIO D	E	eSIM7	F		Android Linux Windows
H				K L	eMBB

主要优势：

- , ,4
-

- USB3.0、PCIe2.0、SDIO 高 接口
- 3GPP Release 15 SA&NSA,向下 容4G/3G

MeiG Smart SRM810模组

5G NR LGA

MEIG 美格

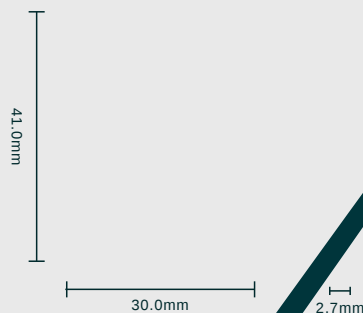
股票代码:0025

基本属性:

- : LGA
- : 30.0×41.0×2.7mm
- : <10g

模组速率:

- 5G NR Sub-6GHz:
 - MIMO 4*4, 256QAM
 - Downlink up to 2.0Gbps
 - Uplink up to 900Mbps
- LTE:
 - Downlink up to 400Mbps
 - Uplink up to 150Mbps
- DC-HSPA+:
 - Downlink up to 42.4Mbps
 - Uplink up to 5.76Mbps



发射功率:

- Class 2 for N41/N78/N79
- Class 1 for LTE-FDD
- Class 3 for LTE-TDD

驱动&工具:

- : Windows 7, Windows 8, Windows 8.1, Windows 10, Linux, Android
-
- USB FOTA

模组接口:

- 1xUSB 2.0/USB 3.0
- 1xPCIe Gen2.0
- 2xUART
- 1xSDIO 3.0
- 2xSIM卡接口(1.8 / 3.0V)
- eSIM
- / / MIMO 4Q
- 1xSPI
- 1xI2C
- GPIOs

环境温湿度特性:

- t₃ t_{tt} : -30°C to 75°C
- : -40°C to 85°C
- : -40°C to 90°C
- : 5%~95%

认证信息:

- CCC*/SRRC*/CTA*